

112

HOUSING MATERIAL: GLASS FILLED HIGH TEMP THERMOPLASTIC UL 94 V-0

SIGNAL CONTACT MATERIAL: COPPER ALLOY POWER CONTACT MATERIAL: COPPER ALLOY

50 u "/I.27 u Ni UNDER ALL; WITH

30 u " / . 76 u Au ON CONTACT AREA, AND

SnPb ON PCB INTERFACE.

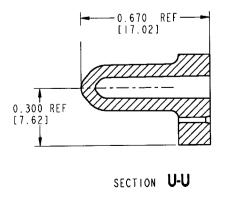
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POWER CONTACTS: 50 u "/1.27 u Ni UNDER ALL: WITH

30 u " / . 76 u Au ON CONTACT AREA. AND SnPb ON PCB INTERFACE.

MANUFACTURER NAME, P/N, AND DATE CODE TO APPEAR ON

- 4. ALL DIMENSIONS ARE BASIC UNLESS OTHERWISE SPECIFIED
- 5. ALL THROUGH HOLES ARE LOCATED WITH A TRUE POSITION OF 0.004"
- 6. ALL DIAMETERS ARE FINISHED HOLE SIZES
- 7. Ø 0.0453/I.151 DRILLED HOLES; PLATED WITH 0.0003/0.007 MIN. SnPb; OVER 0.001/1.03 TO 0.003/0.08 Cu PLATING TO ACHIEVE A Ø 0.040±0.003/1.02±0.07 HOLE.1



1 2

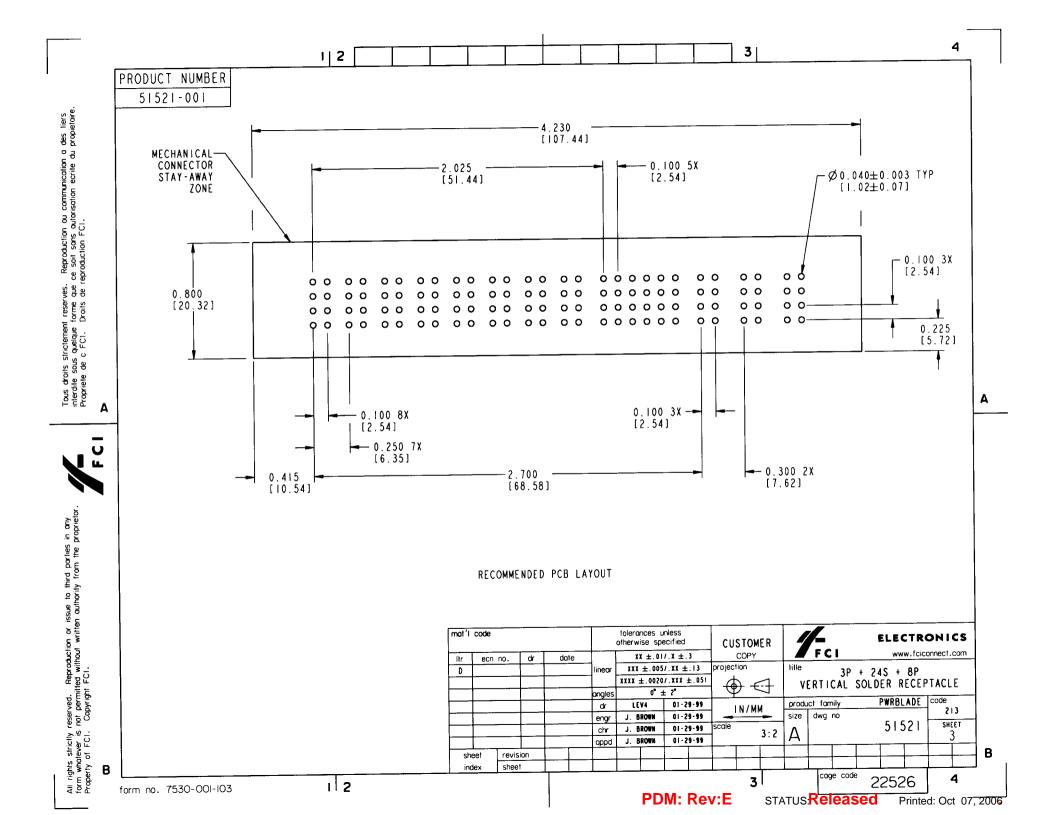
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